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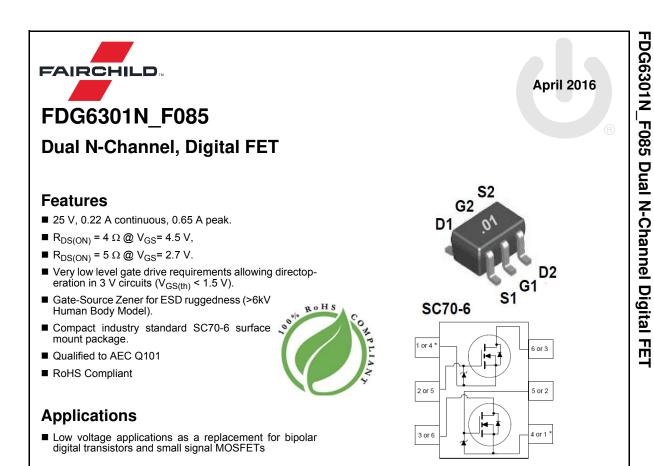
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# **ON Semiconductor**®

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#### MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

| Symbol                            | Parameter  | Ratings     | Units |
|-----------------------------------|--|-------------|-------|
| V <sub>DSS</sub>                  | Drain to Source Voltage  | 25          | V     |
| V <sub>GS</sub>                   | Gate to Source Voltage   | 8           | V     |
| I <sub>D</sub>                    | Drain Current Continuous   | 0.22        | •     |
|                                   | Pulsed   | 0.65        | Α     |
| P <sub>D</sub>                    | Power Dissipation  | 0.3         | W     |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature  | -55 to +150 | °C    |
| ESD                               | Electrostatic Discharge Rating MIL-STD-883D<br>Human Body Model(100 pF / 1500 W) | 6.0         | kV    |
| $R_{\theta JA}$                   | Thermal Resistance, Junction to Ambient  | 415         | °C/W  |

### Package Marking and Ordering Information

| Device Marking | Device        | Package | Reel Size | Tape Width | Quantity   |
|----------------|---------------|---------|-----------|------------|------------|
| FDG6301N       | FDG6301N_F085 | SC70-6  | 7"        | 8mm        | 3000 units |

Notes:

3: Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%.

<sup>1:</sup> R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design, while R<sub>θJA</sub> is determined by the board design. R<sub>θJA</sub> = 415 <sup>o</sup>C/W on minimum pad mounting on FR-4 board in still air

<sup>2:</sup> A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

| Symbol                                     | Parameter                         | Test Conditions  | Min            | Тур         | Max      | Units |
|--|-----------------------------------|--|----------------|-------------|----------|-------|
| Off Cha                                    | racteristics                      |  |                |             |          |       |
| B <sub>VDSS</sub>                          | Drain to Source Breakdown Voltage | I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V   | 25             | -           | -        | V     |
| I <sub>DSS</sub>                           | Zero Gate Voltage Drain Current   | V <sub>DS</sub> = 20V,   | -              | -           | 1        | μA    |
|  |                                   | $V_{GS} = 0V$ $T_J = 55^{\circ}C$  | -              | -           | 10       |       |
| I <sub>GSS</sub>                           | Gate to Source Leakage Current    | V <sub>GS</sub> = ±8V  | -              | -           | ±100     | nA    |
| On Cha                                     | racteristics                      |  |                |             |          |       |
| On Cha                                     | racteristics                      |  | _              |             |          |       |
|  | Gate to Source Threshold Voltage  | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA                                   | 0.65           | 0.85        | 1.5      | V     |
|  |                                   | $V_{GS} = V_{DS}, I_D = 250 \mu A$<br>$I_D = 0.22A, V_{GS} = 4.5V$                           | 0.65           | 0.85<br>2.6 | 1.5<br>4 | V     |
| V <sub>GS(th)</sub>                        |                                   |  | 0.65<br>-<br>- |             |          | V     |
| V <sub>GS(th)</sub><br>r <sub>DS(on)</sub> | Gate to Source Threshold Voltage  | I <sub>D</sub> = 0.22A, V <sub>GS</sub> = 4.5V   | -              | 2.6         | 4        | -     |
| V <sub>GS(th)</sub>                        | Gate to Source Threshold Voltage  | $I_{D} = 0.22A, V_{GS} = 4.5V$ $I_{D} = 0.19A, V_{GS} = 2.7V$ $I_{D} = 0.22A, V_{GS} = 4.5V$ | -              | 2.6<br>3.7  | 4 5      | -     |

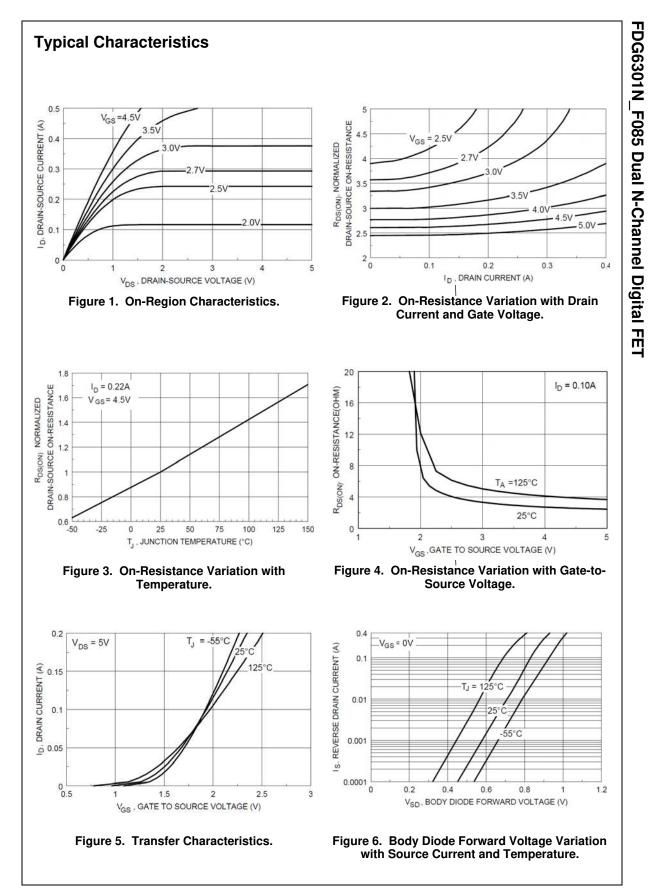
| C <sub>iss</sub>    | Input Capacitance             | V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V,<br>f = 1MHz |            | - | 9.5  | -   | pF |
|---------------------|-------------------------------|--|------------|---|------|-----|----|
| Coss                | Output Capacitance            |  |            | - | 6    | -   | pF |
| C <sub>rss</sub>    | Reverse Transfer Capacitance  |  |            | - | 1.3  | -   | pF |
| Q <sub>g(TOT)</sub> | Total Gate Charge at -4.5V    | $V_{GS}$ = 0 to 4.5V                                     |            | - | 0.29 | 0.4 | nC |
| Q <sub>gs</sub>     | Gate to Source Gate Charge    | $V_{DD} = 5V$<br>$I_{D} = 0.22A$                         |            | - | 0.12 | -   | nC |
| Q <sub>gd</sub>     | Gate to Drain "Miller" Charge |  | ID - 0.22A | - | 0.03 | -   | nC |

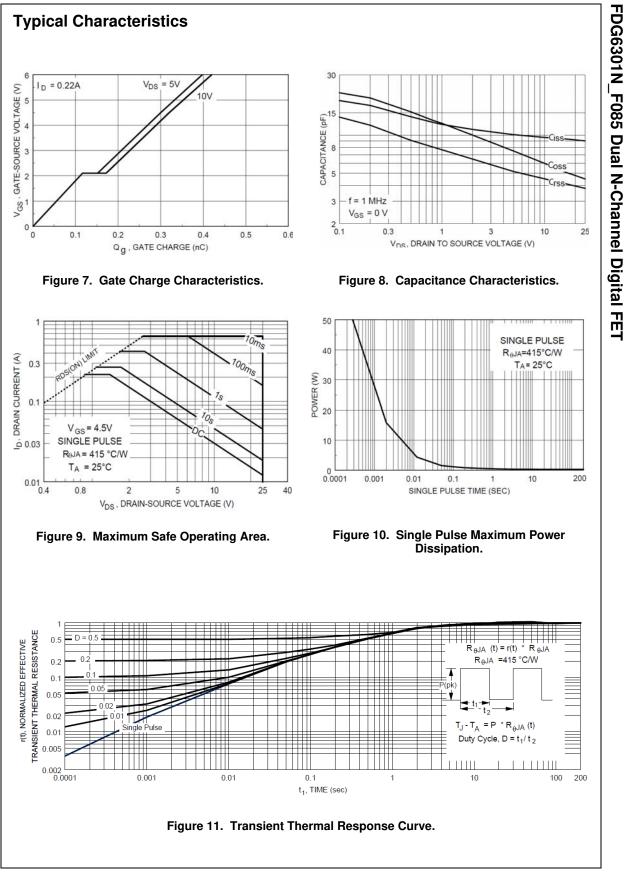
### **Switching Characteristics**

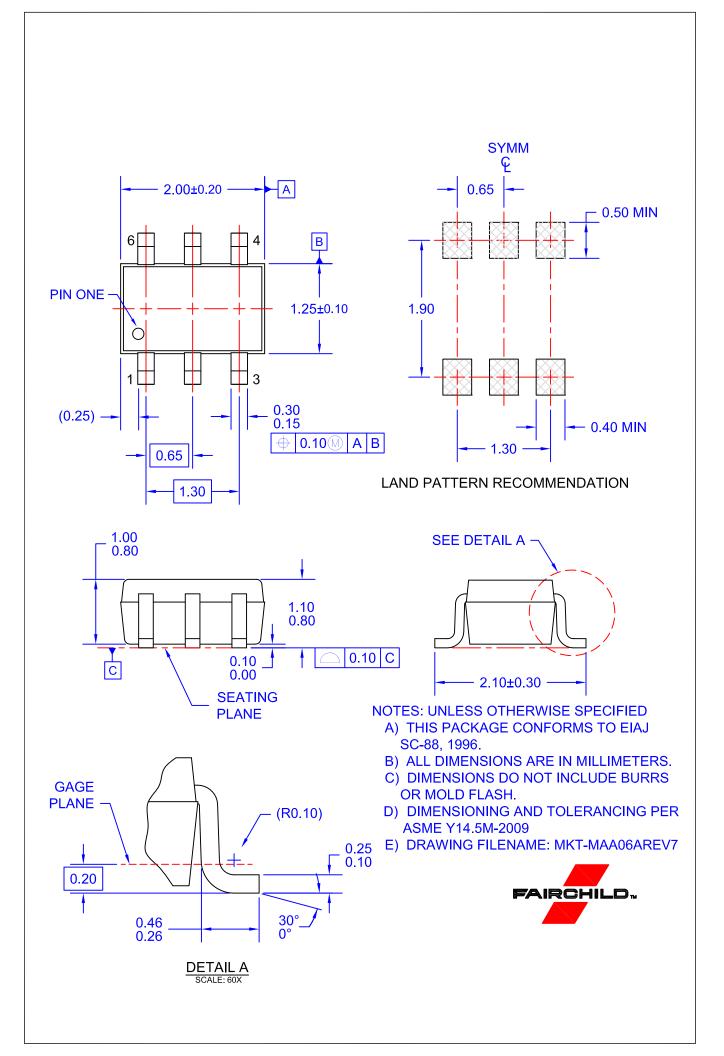
| t <sub>d(on)</sub>  | Turn-On Delay Time  |   | - | 5   | 10 | ns |
|---------------------|---------------------|---|---|-----|----|----|
| t <sub>r</sub>      | Rise Time           | V <sub>DD</sub> = 5V, I <sub>D</sub> = 0.5A<br>V <sub>GS</sub> = 4.5V, R <sub>GEN</sub> = 50Ω | - | 4.5 | 10 | ns |
| t <sub>d(off)</sub> | Turn-Off Delay Time | $V_{\rm GS} = 4.5 \text{V},  \text{R}_{\rm GEN} = 5002$                                       | - | 4   | 8  | ns |
| t <sub>f</sub>      | Fall Time           |   | - | 3.2 | 7  | ns |

#### **Drain-Source Diode Characteristics**

| I <sub>S</sub>  | Maximum Continuous Source Current |   | - | -   | 0.25 | А |
|-----------------|-----------------------------------|---|---|-----|------|---|
| V <sub>SD</sub> | Source to Drain Diode Voltage     | I <sub>SD</sub> = 0.25A, V <sub>GS</sub> = 0V | - | 0.8 | 1.2  | V |







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